WDBR-UL Series



Electronics







Features:

- Ultra low profile thick-film on steel
- Up to 7kW peak power
- Single fixing heatsink mountable
- Ideal for dynamic braking, inrush limit and snubber circuits
- Choice of flying lead or solder terminations
- Low inductance design
- High isolation, even after failsafe overload fusing
- RoHS compliant, non-flammable construction
- UL508 certified—UL file E238661

All Pb-free parts comply with EU Directive 2011/65/EU amended by (EU) 2015/863 (RoHS3)

Electrical Data

		WDBR1UL	WDBR2UL	WDBR3UL	WDBR5UL	WDBR7UL			
Resistance range ⁵	12, 15, 20, 22, 25, 47, 50, 100, 150								
Resistance tolerance	%	10							
Pulse peak power rating ¹	kW	1.5	2	3.5	5	7			
Power rating on heatsink ²	W	170	190	240	250	260			
Power rating on fan cooled heatsink ³	W	660	740	850	950	1410			
TCR	ppm/°C			<+600					
Maximum element temperature °C		450							
Ambient temperature range (heatsink) °C		-55 to +200							
Dielectric withstand ⁴	V (dc/ac pk)	k) 2500							
Inductance	μН	<	3	<4	<5	<6			

- otes:

 1. For details of pulse condition see Fig. 1 in Performance Data.

 2. Mounted on a 0.53°C/W heatsink with no forced air cooling, air temperature 25°C.

 3. Mounted on a 0.53°C/W heatsink with 5m/s forced air cooling, air temperature 25°C.

 4. Based on 100% production test, duration 2s minimum.

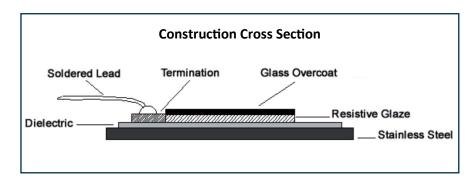
 5. Other ohmic values upon request

Physical Data

Dimensions in mm and weight without terminations in g							_ – d ⊂ l – – – d D l – –			
Туре	L ±0.1	W ±0.1	t ±0.1	ØD nom	a nom	b nom	c nom	d min	Wt.	t = substrate thickness.
WDBR1UL	49.3	35.9		3.2	4.2	17.6	4.2	2.9	12.6	d = clearance between exposed conductor
WDBR2UL	61	40.6	0.9		5.5	19.7	5.5	4.5	17.1	and exposed steel substrate.
WDBR3UL	101.6	70		5.3	14.5	24.8	10.1	7.5	50.8	
WDBR5UL	122	70	1.5	3.3	15.3	27	8.6	7.5	101.2	The fixing hole is centrally located.
WDBR7UL	152.4	101.6	1.5		39.3	10.7	11.8	10.5	181.8	· · · · · · · · · · · · · · · · · · ·

Construction

A high integrity dielectric layer is applied to a machined stainless-steel substrate. Thickfilm conductor and resistor patterns are printed and fired, then protected with a high temperature overglaze. The termination pads are tinned with solder and optional leads are soldered on.



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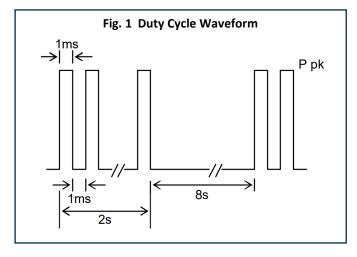
Termination Options

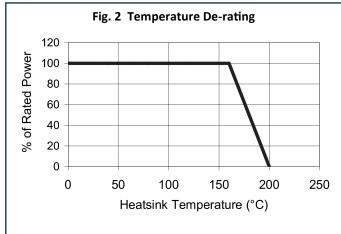
Option	Code	Nominal Dimensions (mm)									
Solder pads		PL ↔	WDBR-UL Size Pad Length, PL	1 & 2 8.8	3	5 & 7 9.1					
only	1	│	Pad Width, PW	5	8.1	6.1					
Flying leads UL3134/5	L	25	50mm	,	≥ √ _{3m}	m					

vote:
Two options exist for solder type. The standard is SnAg (96SC) which is Pb-free and the second (HT) is high temperature HMP alloy which is Pb-bearing. Both are RoHS compliant, but the second relies on the RoHS exemption for high temperature solders and is targeted at specialist high temperature applications.

Performance Data

	±ΔR%
Pulsed load at full pulse power rating 50,000 cycles (see Fig. 1) Mounted on a 0.53°C/W heatsink with 5m/s forced air cooling, air temperature 25°C	5
Derating at heatsink temperatures >160°C	See Fig. 2

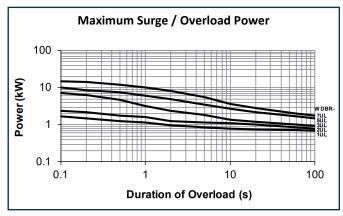


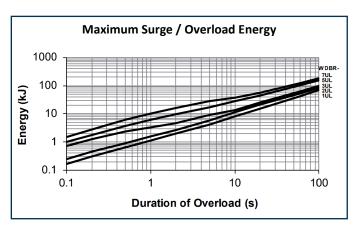




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Pulse and Overload Performance





Note:

Mounted on a 0.53°C/W heatsink with 5m/s forced air cooling, air temperature 25°C. Single pulse or low repetition rate, such that mean power ≤ 10% of rated power. △R ≤ 5%

Maximum Peak Current

Туре	Maximum Peak Current (A)					
	12R – 25R	47R – 150R				
WDBR1UL	21.6	8.1				
WDBR2UL	20.5	9				
WDBR3UL	25.4	11.4				
WDBR5UL	27.8	10.2				
WDBR7UL	44.5	20.3				

Application Notes

A heatsink with thermal resistance ≤0.53°C/W will enable the component to operate at its continuous power rating. Sufficient thermal grease (e.g. Dow Corning DC340) to give void-free coverage, or a 0.5mm thick compliant thermal pad (e.g. T Global TG-X) should be used and the heatsink should have a surface finish of <6.3µm with flatness of <0.05mm. The resistor should be mounted using an appropriate bolt as listed in the table below. This should be tightened so as to bring the whole area of the steel substrate into intimate contact with the heatsink. The unmounted part is slightly bowed so that the centre is above the edges. Inadequate tightening will leave the centre out of contact with the heatsink, whilst over tightening can cause the edges to rise. The tightening torque required will depend on the fixings and heatsink used, but typical figures are given for guidance.

Туре	Bolt Size	Typical Tightening Torque (Nm)			
WDBR1UL	M3	2			
WDBR2UL		2.5			
WDBR3UL	M5	2.5			
WDBR5UL	IVIO	3.5			
WDBR7UL		4			

WDBR-UL resistors will fail safe (open circuit) under overload fault conditions and still maintain a 1kV dielectric withstand.

Soldering of solder pad (termination I) variants requires the use of a hot plate. Hand solder process recommendations are available.

WDBR-UL resistors may be customised in various ways including:

- Alternative shapes and dimensions up to 406mm x 406mm
- Integration of temperature measurement elements and thermal cutouts
- Alternative ohmic values and tolerances
- Increased dielectric withstand voltage
- Custom braking resistors with UL approval
- Integration of multiple power resistors



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Ordering Procedure

Example: WDBR2UL-100RKLW (WDBR2UL with standard solder and flying lead terminations, 100 ohms ±10%, Pb-free)



1	2	3	4	5	6		7	
Size	Certification	Solder Option	Value	Tolerance	Termination	Packing		
WDBR1	UL = UL508	Omit for	3/4 characters	K = ±10%	I = Solder	W = Standard packing		
WDBR2		standard (96SC)	R = ohms		pads only	Term. I	Term. L	Bulk pack
WDBR3		HT = High	,		L = Flying	1 & 2		100/box
WDBR5		Temperature			leads	3 & 5	1 & 2	40/box
WDBR7						7	3, 5 & 7	20/box

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